



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L0303-02** DATE: 3/10/2003
 Product Affected: IDT74CBTLV16245PA
 IDT74CBTLV16245PF
 IDT74CBTLV16245PV
 Date Effective: March 10, 2003

MEANS OF DISTINGUISHING CHANGED DEVICES:
 Product Mark
 Back Mark
 Date Code
 Other N/A - Data Sheet Errata

Contact: Bimla Paul
 Title: Quality Assurance Manager
 Phone #: (408)-654-6419
 Fax #: (408)-492-8362
 E-mail: bimla.paul@idt.com

Attachment: Yes No
 Samples: N/A

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process
- Assembly Process
- Equipment
- Material
- Testing
- Manufacturing Site
- Data Sheet
- Other

To correct pin configuration in the data sheet. Following pins were mislabeled in the datasheet. No connection is required on these four pins. The device has several true Vcc and GND pins. Therefore, this change does not have any impact on the device functionality.

Pin No.	Incorrect	Correct
7, 42	Vcc	No Connect (NC)
4, 45	GND	No Connect (NC)

RELIABILITY/QUALIFICATION SUMMARY:

There is no change in quality and reliability of the product.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____

Approval for shipments prior to effective date.

Name/Date: _____

E-Mail Address: _____

Title: _____

Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____

DATE: _____